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Kind regards,

Team Nexperia

74HC590

8-bit binary counter with output register; 3-state Rev. 3 — 24 February 2016 Pro

Product data sheet

1. **General description**

The 74HC590 is an 8-bit binary counter with a storage register and 3-state outputs. The storage register has parallel (Q0 to Q7) outputs. The binary counter features master reset counter (MRC) and count enable (CE) inputs. The counter and storage register have separate positive edge triggered clock (CPC and CPR) inputs. If both clocks are connected together, the counter state is always one count ahead of the register. Internal circuitry prevents clocking from the clock enable. A ripple carry output (RCO) is provided for cascading. Cascading is accomplished by connecting RCO of the first stage to CE of the second stage. Cascading for larger count chains can be accomplished by connecting RCO of each stage to the counter clock (CPC) input of the following stage. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Features and benefits 2.

- Counter and register have independent clock inputs
- Counter has master reset
- Complies with JEDEC standard no. 7A
- Multiple package options
- Input levels:
 - For 74HC590: CMOS level
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 2000 V
- Specified from −40 °C to +85 °C and from −40 °C to +125 °C

Ordering information 3.

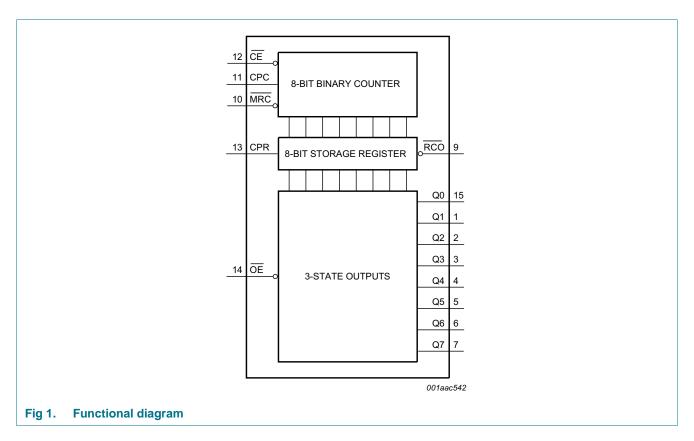
Table 1. **Ordering information**

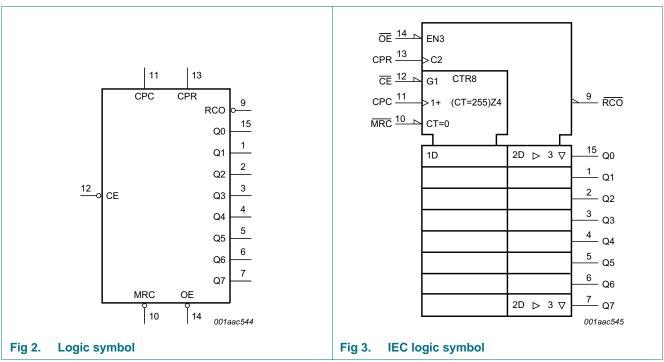
Type number	Package	Package										
	Temperature range	Name	Description	Version								
74HC590D	−40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1								
74HC590PW												
74HC590BQ	–40 °C to +125 °C		plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1								



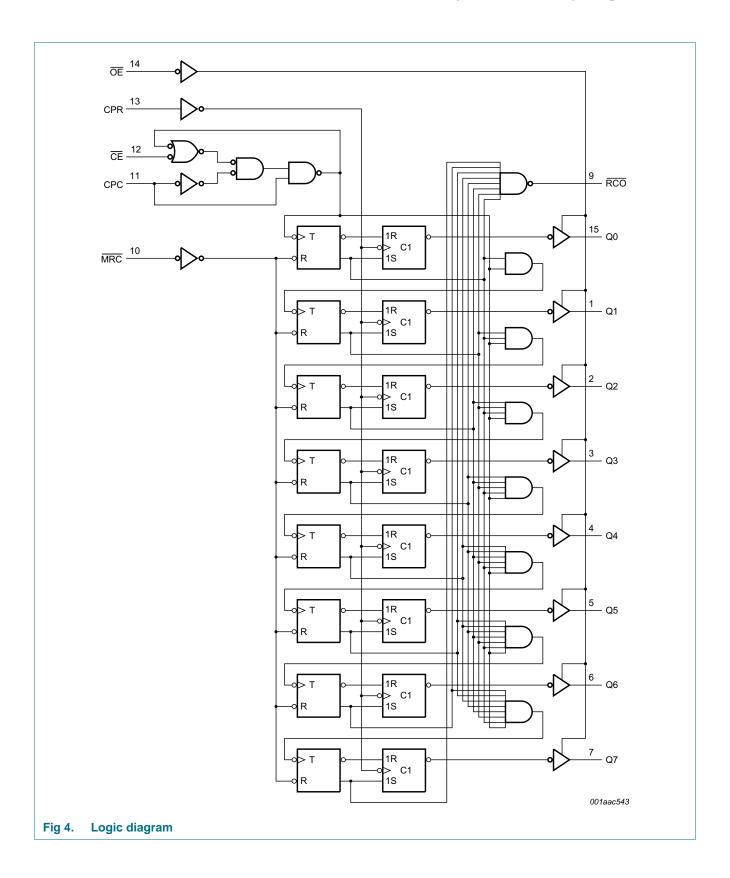
8-bit binary counter with output register; 3-state

4. Functional diagram





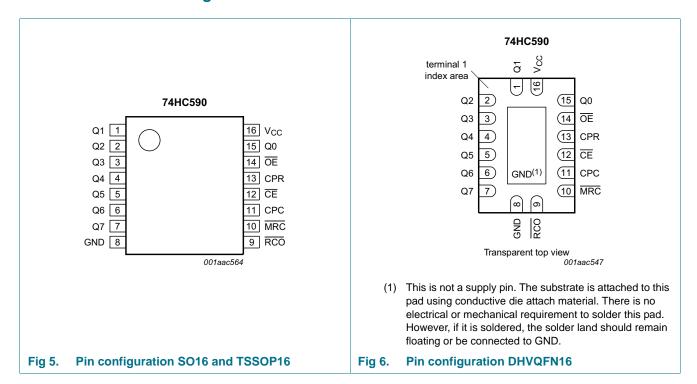
8-bit binary counter with output register; 3-state



8-bit binary counter with output register; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Q0 to Q7	15, 1, 2, 3, 4, 5, 6, 7	parallel data output
GND	8	ground (0 V)
RCO	9	ripple carry output (active LOW)
MRC	10	master reset counter input (active LOW)
CPC	11	counter clock input (active HIGH)
CE	12	count enable input (active LOW)
CPR	13	register clock input (active HIGH)
ŌĒ	14	output enable input (active LOW)
V _{CC}	16	supply voltage

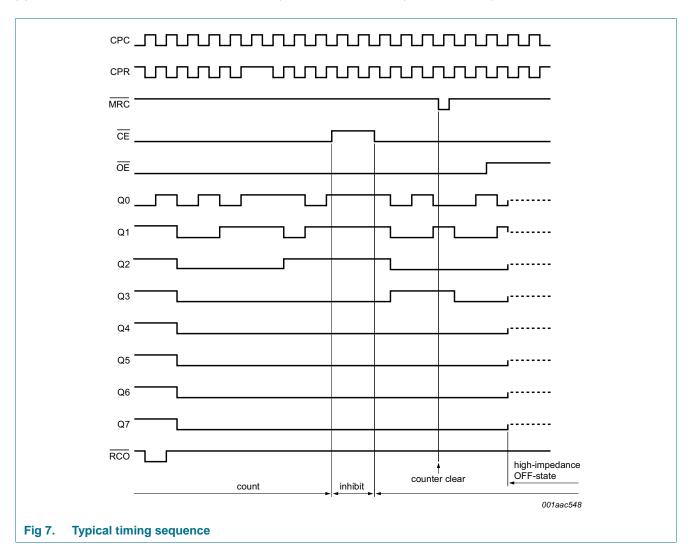
8-bit binary counter with output register; 3-state

6. Functional description

Table 3. Function table [1] [2]

Inputs					Description
OE	CPR	MRC	CE	CPC	
Н	Х	Х	Х	X	Q outputs disable
L	Х	Х	Х	X	Q outputs enable
Х	1	X	Х	X	counter data stored into register
Х	\	Х	Х	X	register stage is not changed
Х	Х	L	Х	X	counter clear
Х	Х	Н	L	1	advance one count
Х	Х	Н	L	\downarrow	no count
Х	Х	Н	Н	X	no count

- [1] H = HIGH voltage level; L = LOW voltage level; X = don't care; ↑ = LOW-to-HIGH transition; ↓ = HIGH-to-LOW transition.
- [2] $\overline{RCO} = \overline{Q0' \cdot Q1' \cdot Q2' \cdot Q3' \cdot Q4' \cdot Q5' \cdot Q6' \cdot Q7'}$ (Q0' to Q7' are internal outputs of the counter).



8-bit binary counter with output register; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$				
		RCO standard output		-	±25	mA
		Qn bus driver output		-	±35	mA
I _{CC}	supply current			-	70	mA
I _{GND}	ground current			-70	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2]			
		SO16 package		-	500	mW
		TSSOP16 package		-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	ns/V
		V _{CC} = 4.5 V	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	ns/V
T _{amb}	ambient temperature		-40	-	+125	°C

^[2] For SO16 packages: P_{tot} derates linearly with 8 mW/K above 70 °C.
For TSSOP16 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
For DHVQFN16 packages: P_{tot} derates linearly with 8 mW/K above 60 °C.

8-bit binary counter with output register; 3-state

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V_{IL}	LOW-level	V _{CC} = 2.0 V	-	8.0	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	all outputs								
		$I_O = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	5.9	-	V
		RCO standard output								
		$I_{O} = -4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.18	4.31	-	4.13	-	4.1	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.68	5.80	-	5.63	-	5.6	-	V
		Qn bus driver output								
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.18	4.31	-	4.13	-	4.1	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.68	5.80	-	5.63	-	5.6	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	all outputs								
		$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		RCO standard output								
		$I_{O} = 4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.17	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.18	0.26	-	0.33	-	0.4	V
		Qn bus driver output								
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.17	0.26	-	0.33	-	0.4	V
		$I_{O} = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.18	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL};$ $V_O = V_{CC} \text{ or GND};$ $V_{CC} = 6.0 \text{ V}$	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

8-bit binary counter with output register; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V); for test circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{pd}	propagation	CPC to RCO; see Figure 8	1]							
	delay	V _{CC} = 2.0 V	-	52	150	-	190	-	230	ns
		V _{CC} = 4.5 V	-	19	30	-	38	-	45	ns
		V _{CC} = 6.0 V	-	15	26	-	33	-	40	ns
		CPR to Qn; see Figure 9								
		V _{CC} = 2.0 V	-	50	140	-	175	-	210	ns
		V _{CC} = 4.5 V	-	17	28	-	35	-	42	ns
		V _{CC} = 6.0 V	-	14	24	-	30	-	36	ns
t _{PLH}	LOW to HIGH	MRC to RCO; see Figure 10								
	propagation	V _{CC} = 2.0 V	-	53	130	-	165	-	200	ns
	delay	V _{CC} = 4.5 V	-	18	26	-	33	-	40	ns
		V _{CC} = 6.0 V	-	14	22	-	28	-	34	ns
t _{en}	enable time	OE to Qn; see Figure 11	2]							
		V _{CC} = 2.0 V	-	28	105	-	130	-	160	ns
		V _{CC} = 4.5 V	-	13	21	-	26	-	32	ns
		V _{CC} = 6.0 V	-	11	18	-	22	-	27	ns
t _{dis}	disable time	OE to Qn; see Figure 11	3]							
		V _{CC} = 2.0 V	-	28	105	-	130	-	160	ns
		V _{CC} = 4.5 V	-	13	21	-	26	-	32	ns
		V _{CC} = 6.0 V	-	11	18	-	22	-	27	ns
t _W	pulse width	CPC and CPR; HIGH or LOW; see Figure 8 and Figure 9								
		V _{CC} = 2.0 V	100	24	-	125	-	145	-	ns
		V _{CC} = 4.5 V	20	9	-	25	-	29	-	ns
		V _{CC} = 6.0 V	17	8	-	21	-	25	-	ns
		MRC; LOW; see Figure 10								
		V _{CC} = 2.0 V	75	28	-	95	-	110	-	ns
		V _{CC} = 4.5 V	15	8	-	19	-	22	-	ns
		V _{CC} = 6.0 V	13	6	-	16	-	19	-	ns
t _{su}	set-up time	CPC to CPR; see Figure 13								
		V _{CC} = 2.0 V	100	46	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	14	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	10	-	21	-	26	-	ns
		CE to CPC; see Figure 12								1
		V _{CC} = 2.0 V	100	44	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	11	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	9	-	21	-	26	-	ns

74HC590

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8-bit binary counter with output register; 3-state

Table 7. Dynamic characteristics ...continued GND (ground = 0 V); for test circuit see <u>Figure 14</u>.

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _h	hold time	CE to CPC; see Figure 12								
		V _{CC} = 2.0 V	0	-	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-	-	0	-	0	-	ns
t _{rec}	recovery time	MRC to CPC; see Figure 10								
		V _{CC} = 2.0 V	75	28	-	95	-	110	-	ns
		V _{CC} = 4.5 V	15	7	-	19	-	22	-	ns
		V _{CC} = 6.0 V	13	6	-	16	-	19	-	ns
f _{max}	maximum frequency	CPC or CPR; see Figure 8 and Figure 9								
		V _{CC} = 2.0 V	6.6	16	-	5.2	-	4.4	-	MHz
		V _{CC} = 4.5 V	33	52	-	26	-	22	-	MHz
		V _{CC} = 6.0 V	39	61	-	31	-	26	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$ [4]	-	44	-	-	-	-	-	pF

- [1] t_{pd} is the same as t_{PHL} , t_{PLH} .
- [2] t_{en} is the same as t_{PZH} and t_{PZL} .
- [3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz;

fo = output frequency in MHz;

C_L = output load capacitance in pF;

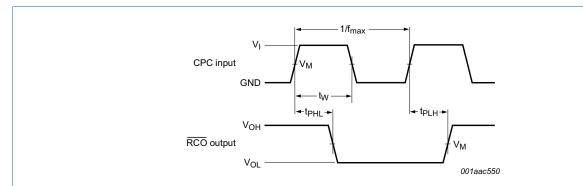
V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = sum of outputs.$

8-bit binary counter with output register; 3-state

11. Waveforms



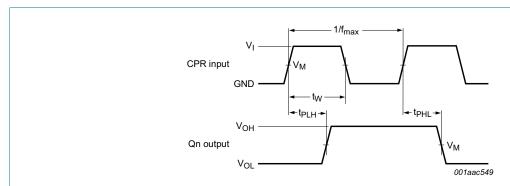
Measurement points are given in Table 8.

V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 8. Waveforms showing the propagation delays from the counter clock input (CPC) to ripple carry (RCO) output and the CPC pulse width

Table 8. Measurement points

Туре	Input		Output
	V _I	V _M	V _M
74HC590	V _{CC}	0.5V _{CC}	0.5V _{CC}



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 9. Waveforms showing the propagation delays from the register clock input (CPR) to output (Qn) and the register clock pulse width

8-bit binary counter with output register; 3-state

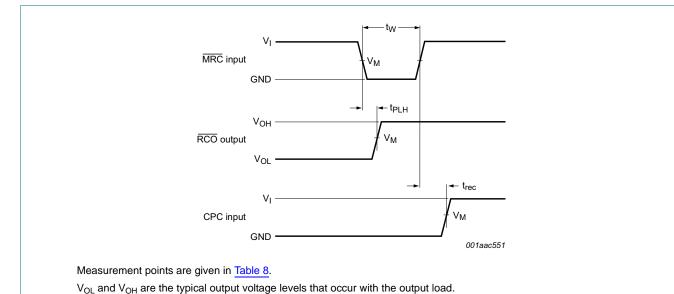
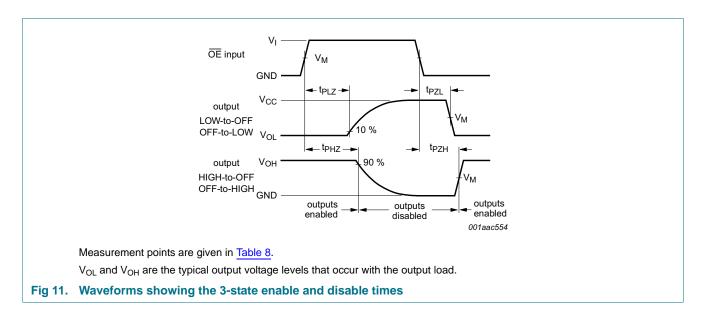
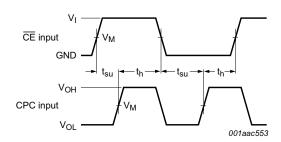


Fig 10. Waveforms showing the propagation delays from the master reset counter input (MRC) to output (RCO), the MRC pulse width and recovery time



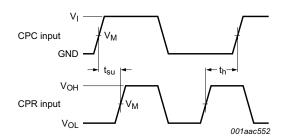
8-bit binary counter with output register; 3-state



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 12. Waveforms showing the set-up and hold times for the count enable input (CE) to the counter clock input (CPC)

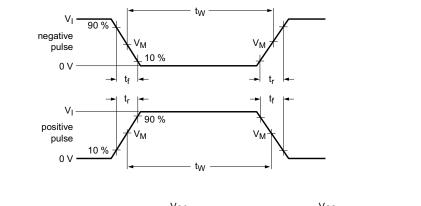


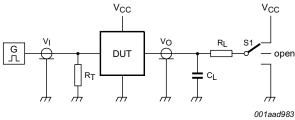
Measurement points are given in Table 8.

 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 13. Waveforms showing the set-up and hold times for the counter clock input (CPC) to the register clock input (CPR)

8-bit binary counter with output register; 3-state





Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

 R_L = Load resistance.

S1 = Test selection switch.

Fig 14. Test circuit for measuring switching times

Table 9. Test data

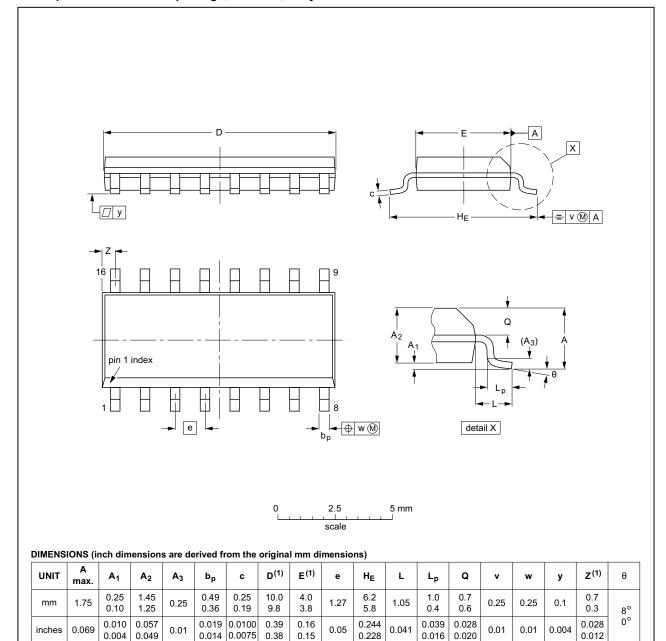
Supply voltage	Input		Load		Switch position					
V _{CC}	V _I t _r , t _f		CL	R _L	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}			
2.0 V to 6.0 V	V _{CC} 6 ns		50 pF		open	GND	V _{CC}			

8-bit binary counter with output register; 3-state

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012			99-12-27 03-02-19

Fig 15. Package outline SOT109-1 (SO16)

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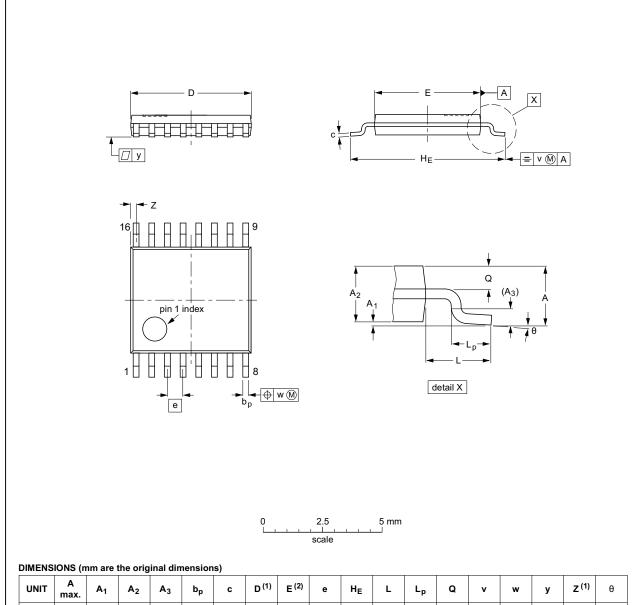
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74HC590 **NXP Semiconductors**

8-bit binary counter with output register; 3-state

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNI	IT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mn	n	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				99-12-27 03-02-18
_	VERSION	VERSION IEC	VERSION IEC JEDEC	VERSION IEC JEDEC JEITA	VERSION IEC JEDEC JEITA	VERSION IEC JEDEC JEITA PROJECTION

Fig 16. Package outline SOT403-1 (TSSOP16)

74HC590 **NXP Semiconductors**

8-bit binary counter with output register; 3-state

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

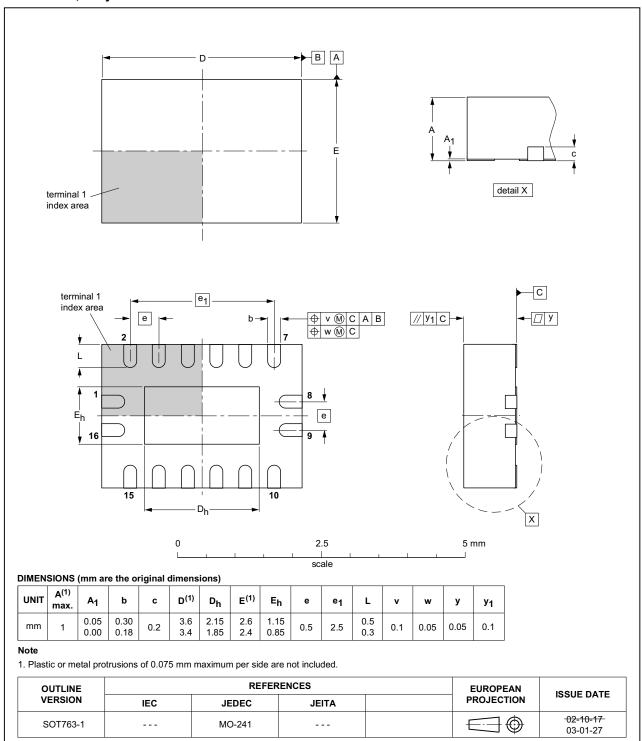


Fig 17. Package outline SOT763-1 (DHVQFN16)

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8-bit binary counter with output register; 3-state

13. Abbreviations

Table 10. Abbreviations

Acronym	Description	
CDM	Charged Device Model	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC590 v.3	20160224	Product data sheet	-	74HC590 v.2		
Modifications:	Type numb	er 74HC590N (SOT38-4) r	emoved.			
74HC590 v.2	20090428	Product data sheet	-	74HC590 v.1		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
	 Quick reference data incorporated in to <u>Section 9</u> and <u>Section 10</u>. 					
	 Added type number 74HC590N (DIP16 package) 					
74HC590 v.1	20050330	Product data sheet	-	-		

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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